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	APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
_	10/528,440	03/18/2005	Kazuhiro Fujikawa	4858	4308
	21553	7590 08/22/2007		EXAM	INER
	P.O. BOX 726			LE, TH	IAO P
	HAMPDEN, M	1E 04444-0726		ART UNIT	PAPER NUMBER
				2818	
				MAIL DATE	DELIVERY MODE
				08/22/2007	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

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***************************************	Application No.	Applicant(s)	\1.19_			
	10/528,440	FUJIKAWA ET AL.				
Office Action Summary	Examiner	Art Unit	· · · · · · · · · · · · · · · · · · ·			
	Thao P. Le	2818				
The MAILING DATE of this communication ap Period for Reply	ppears on the cover sheet w	vith the correspondence addres	is			
A SHORTENED STATUTORY PERIOD FOR REPL WHICHEVER IS LONGER, FROM THE MAILING IDEA of time may be available under the provisions of 37 CFR 1 after SIX (6) MONTHS from the mailing date of this communication.  If NO period for reply is specified above, the maximum statutory period for reply within the set or extended period for reply will, by stature Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	DATE OF THIS COMMUNI.  136(a). In no event, however, may a d will apply and will expire SIX (6) MO te, cause the application to become A	ICATION. reply be timely filed  NTHS from the mailing date of this community BANDONED (35 U.S.C. § 133).				
Status						
1) Responsive to communication(s) filed on 25.	July 2007.					
2a)⊠ This action is <b>FINAL</b> . 2b)□ Thi	is action is non-final.					
3) Since this application is in condition for allowa	ance except for formal mat	ters, prosecution as to the me	rits is			
closed in accordance with the practice under	Ex parte Quayle, 1935 C.I	D. 11, 453 O.G. 213.				
Disposition of Claims						
4) Claim(s) <u>1,6-8,10,11,25-27 and 29-32</u> is/are p	pending in the application.					
4a) Of the above claim(s) is/are withdra	awn from consideration.					
5) Claim(s) <u>1,6-8,10,11,25-27,29 and 30</u> is/are a	5)⊠ Claim(s) <u>1,6-8,10,11,25-27,29 and 30</u> is/are allowed.					
6)⊠ Claim(s) <u>31 and 32</u> is/are rejected.						
7) Claim(s) is/are objected to.						
8) Claim(s) are subject to restriction and/	or election requirement.					
Application Papers						
9) The specification is objected to by the Examin	er.					
10)⊠ The drawing(s) filed on <u>18 March 2005</u> is/are: a)⊠ accepted or b)□ objected to by the Examiner.						
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).						
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).						
11) ☐ The oath or declaration is objected to by the E	xaminer. Note the attache	d Office Action or form PTO-1	52.			
Priority under 35 U.S.C. § 119						
12)⊠ Acknowledgment is made of a claim for foreig	n priority under 35 U.S.C.	§ 119(a)-(d) or (f).				
a)⊠ All b)□ Some * c)□ None of:	•					
1. Certified copies of the priority documen	nts have been received.					
2. Certified copies of the priority documen		Application No				
3. Copies of the certified copies of the price	ority documents have beer	received in this National Stag	је			
application from the International Bureau (PCT Rule 17.2(a)).  * See the attached detailed Office action for a list of the certified copies not received.						
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Attachment(s)						
1) Notice of References Cited (PTO-892)	4) Interview	Summary (PTO-413)				
2) Notice of Draftsperson's Patent Drawing Review (PTO-948)	Paper No	(s)/Mail Date				
3) Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date 6/4/07.	5) Notice of Other:	Informal Patent Application				

## Response to Amendment

This office action is in response to Amendments filed on 07/25/2007.

Claims 1, 6-8, 10-11, 25-27, 29-32 are pending.

Claims 1, 26, 27, 30-32 have been amended.

Claims 2-5, 9, 12-24, 28 have been cancelled.

Remarks of applicants are fully considered. The previous final rejection has been withdrawn. Indication of "would be allowed" of claims 31-32 in the previous office action was a typo mistake. Claims 31-32 should have been rejected as same as claims 10-11 in the previous office action.

## Information Disclosure Statement

The information disclosure statement (IDS) submitted on 06/04/2007 after the mailing date of the application. The submission is in compliance with the provisions of 37 CFR 1.97. Accordingly, the information disclosure statement is being considered by the examiner.

## Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention

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was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 31-32 are rejected under 35 USC 103 (a) as being anticipated by Japan Publication No. 04-002120 (submitted by IDS), in view of AAPA (Applicant Admitted Prior Art).

Regarding claims 31-32, Japan Publication No. 04-002120 discloses a method of fabricating a semiconductor device by employing ion implantation to provide a semiconductor substrate 1 at a surface thereof with a region having dopant introduced therein, comprising the steps of: providing the substrate 1 at a surface thereof with a mask layer 2 including a polyimide resin film 2, and implanting dopant ions into the substrate (Constitution). Japan Publication No. 04-002120's abstract doesn't mention that the substrate is SiC. It is well known in the art that SiC is used in the method of forming the devices such as MOS or FET in Japan Publication No. 04-002120. AAPA discloses the use of SiC layer as substrate (Page 1 of Specification). It would have been obvious to one having ordinary skill in the art at the time the invention was made to use SiC as a substrate material because SiC material has wide band gap, large insulting electric field.

Still regarding claims 31-32, Japan Publication No. 04-002120 fails to disclose the substrate is heated to at least 300 oC or 500 oC for dopant ions are implanted. However, it would have been well know in the art that the high

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temperature of about 800 to thousand and some hundreds degrees are used to heat the SiC substrate during the ion implantation. In addition, the selection of such parameters such as energy, concentration, temperature, time, molar fraction, depth, thickness, etc., would have been obvious and involve routine optimization which has been held to be within the level of ordinary skill in the art. "Normally, it is to be expected that a change in energy, concentration, temperature, time, molar fraction, depth, thickness, etc., or in conbination of the parameters would be an unpatentable modification. Under some circumstances, however, changes such as these may impart patentability to a process if the particular ranges claimed produce a new and unexpected result which is different in kind and not merely degree from the results of the prior art ... such ranges are termed "critical ranges and the applicant has the burden of proving such criticality.... More particularly, where the general conditions of a claim are disclosed in the prior art, it is not inventive to discover the optimum or workable ranges by routine experimentation." In re Aller 105 USPQ233, 255 (CCPA 1955). See also In re Waite 77 USPQ 586 (CCPA 1948); In re Scherl 70 USPQ 204 (CCPA 1946); In re Irmscher 66 USPQ 314 (CCPA 1945); In re Norman 66 USPQ 308 (CCPA 1945); In re Swenson 56 USPQ 372 (CCPA 1942); In re Sola 25 USPQ 433 (CCPA 1935); In re Dreyfus 24 USPQ 52 (CCPA 1934).

Still regarding claims 31-32, Japan Publication No. 04-002120's abstract doesn't mention the thin metal film or SiO2 is posed between the polyimide and

Page 5

the substrate. However, AAPA states that metal layer or SiO2 layer is formed on top of the substrate as a mask in the ion implantation process (Pages 2-3). It would have been obvious to one having ordinary skill in the art at the time the invention was made to form a metal thin film or SiO2 layer between the substrate and the polyimide in order to ensure high energy implantation in an environment of high temperature (page 3).

Claims 1, 6-8, 10-11, 25-27, 29-30 are allowed.

## Conclusion

For the above reasons, it is believed that the rejections should be sustained. Feature of an invention not found in the claims can be given no patentable weight in distinguishing the claimed invention over the prior art.

Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP '706.07(a). Applicants are reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for response to this final action is set to expire THREE MONTHS from the date of this action. In the event a first response is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37

CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event will the statutory period for response expire later than SIX MONTHS from the date of this final action.

When responding to the office action, Applicants are advised to provide the examiner with the line numbers and page numbers in the application and/or references cited to assist the examiner to locate the appropriate paragraphs.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to whose telephone number is (571) 272-1785. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Matthew Smith, can be reached on 571-272-1907. Other inquiries of this application should be called to (571) 272-1562 or the fax number (571)-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-

free).

Thao P. Le

Primary Examiner

August 16, 2007.